Applicabl	e standard	<u> </u>								
Operating			-35°C to +85°C(Notes 1)		Sto	Storage -10°C to ±60°C			Notos)	
	temperature ra	ange	,		temperature range		ange	-10°C to +60°C(Note3)		
Rating	Operating humidity range		20 % to 80 % (Notes 2)			Storage humidity range		40 % to 70 %(N	iote3)	
	Voltage		150 V AC (DC)		Current		_	1 A/pin		
	Applicable		DF13-*DS-1.25C		Applicable			DF13(G)-2630SCF		
	Connector				Contact			DF13-3032SCF		
			Spe	cificat	ior	າຣ				
lt	em		Test method			Requirements			QT	АТ
Construc	tion	*				*				
General examination		Visually and by measuring instrument.				According to drawing.			Х	Х
Marking		Confirme	d visually.						Χ	Х
Electric c	characteris									
Contact resistance		AC 20mV, 1mA (DC OR 1000 Hz).				30 mΩ MAX.			Х	_
Insulation resistance		100 V DC.			500 MΩ MIN.				Х	-
Voltage proof		500 V AC	500 V AC for 1 min.			No flashover or breakdown.			Х	<u> </u>
Mechanio	cal charac	teristics				I				1
Mechanical o	peration	30 times	30 times insertions and extractions.			1) Conta	1) Contact resistance: 30 m Ω MAX.			
Vibration		Frequency 10 to 55 Hz, single appelitude				2) No damage, crack or looseness of parts.			X	
Vibration		Frequency 10 to 55 Hz, single amplitude 0.75 mm, at 2 h, for 3 directions.					1) No electrical discontinuity of 1μs. 2) No damage, crack or looseness of parts.			_
Shock		490 m/s ² duration of pulse 11 ms at 3 times for 3				7				
		directions							X	
Environm Rapid chang	nental cha					la) Camb		e: 30mΩ MAX.		1
temperature		Temperature $-55^{\circ}C \rightarrow +85^{\circ}C$ Time $30 \text{min} \rightarrow 30 \text{min}$			 Contact resistance: 30mΩ MAX. Insulation resistance: 500 MΩ MIN. 			X		
			Under 5 Cycles.				3) No damage, crack or looseness of parts.			_
Damp heat			(The transferring time of the tank is 2 to 3 MIN)							
(Steady state)		Exposed at 40±2 °C, 90 to 95 %, 96 h.							X	-
Resistance to	o soldering		soldering			No deformation of case of excessive looseness			s X	
heat		≪ Reflow area ≫ 250°C MAX 10 sec MAX				of the to	of the terminals.			_
		230°C MIAX 10 sec MAX 230°C MIN 60 sec MAX ≪ Preheating area ≫ 170°C to 190°C 60 sec to 120 sec Put through in reflow furnace twice, leave in ambient temperature and humidity for 1 hour. 2) Manual soldering Soldering iron temperature :300°C, Soldering time: 3sec.								
			ength on contact.							
Solderability			Soldered at solder temperature,			Solder shall cover a minimum of				
		245°c for	insertion duration, 3sec.			95 % c	of the surface	e being immersed.	X	
Remarks										
Note 1: Includ Note 2: No co	le the temperatu Indensing	ire rising by o	current.							
Note 3: Apply	to the condition	_	storage for unused products bef							
			temperature and humidity range				during transp			
Cour	·				signed Checked			Dat	e	
1			DIS-H-00009653			. SATO		SZ. ONO	20210608	
Unless o	therwise s	specified	pecified, refer to IEC 60512.			Apı	proved	HS. OKAWA	20200313	
						Ch	ecked	TS. KUMAZAWA		
						Designed		HK. HAYASHI	20200313	
						D	rawn	DS. HIROWATARI	20200306	
Note QT:Qualification Test AT:Assurance Test X:Applicable Test					Drawing no.		ELC-367982-22-00			
HS.		Spe	Specification sheet			art no.	D	F13EA-*DP-1. 25V(22)	
		Hirose electric co., ltd.			Co	ode no.		CL536	1	1/1
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